

PDFN5060 Plastic-Encapsulate MOSFETS

Features

- VDS=40V
- ID=65A
- RDS(on)@VGS=10V < 6mΩ
- RDS(on)@VGS=4.5V < 8mΩ
- High density cell design for ultra low Rdson
- Voltage controlled small signal switch
- Fast Switching Speedze

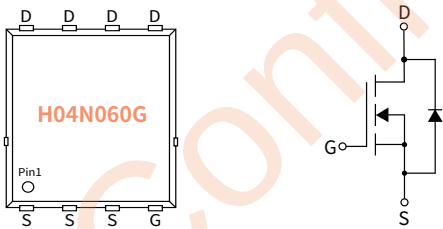
Applications

- DC-DC Converters
- Motor Control
- Portable equipment application

Mechanical Data

- Case: PDFN5060
Molding compound meets UL 94V-0 flammability rating, RoHS-compliant,halogen-free
- Terminals: Solder plated, solderable per MIL-STD-750,Method 2026

Function Diagram



Drain-source Voltage
40 V
Drain Current
65 Ampere



Ordering Information

Table with 7 columns: PACKAGE, PACKAGE CODE, UNIT WEIGHT(g), REEL(pcs), BOX(pcs), CARTON(pcs), DELIVERY MODE. Row 1: PDFN5060, R3, 0.09, 5000, 10000, 80000, 13"

Maximum Ratings (Ta=25°C Unless otherwise specified)

Table with 4 columns: PARAMETER, SYMBOL, UNIT, VALUE. Rows include: Drain-source Voltage (VDS, V, 40), Gate-source Voltage (VGS, V, ±20), Drain Current (ID, A, 65), Pulsed Drain Current (IDM, A, 260), Total Power Dissipation (PD, W, 65), Single pulse avalanche energy (EAS, mJ, 110), Junction temperature (TJ, °C, -55 ~+150), Storage temperature (Tstg, °C, -55 ~+150), Thermal Resistance Junction-to-Case (RθJC, °C / W, 1.92).

# HD504N060SG

N-CHANNEL MOSFET

● Static Parameter Characteristics (Tj=25°C Unless otherwise specified)

| PARAMETER                                        | SYMBOL       | Condition                     | UNIT       | Min | Typ | Max       |
|--------------------------------------------------|--------------|-------------------------------|------------|-----|-----|-----------|
| Drain-Source Breakdown Voltage                   | $BV_{DSS}$   | $V_{GS}=0V, I_D=250\mu A$     | V          | 40  | —   | —         |
| Zero Gate Voltage Drain Current                  | $I_{DSS}$    | $V_{DS}=40V, V_{GS}=0V$       | $\mu A$    | —   | —   | 1.0       |
| Gate-Body Leakage Current                        | $I_{GSS}$    | $V_{GS}=\pm 20V, V_{DS}=0V$   | nA         | —   | —   | $\pm 100$ |
| Gate Threshold Voltage                           | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | V          | 1.0 | 1.5 | 2.5       |
| Static Drain-Source On-Resistance <sup>(3)</sup> | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=20A$         | m $\Omega$ | —   | 4.5 | 6         |
|                                                  | $R_{DS(ON)}$ | $V_{GS}=4.5V, I_D=10A$        |            | —   | 6.2 | 8         |

● Dynamic Parameters

| PARAMETER                    | SYMBOL    | Condition                       | UNIT | Min | Typ | Max |
|------------------------------|-----------|---------------------------------|------|-----|-----|-----|
| Input Capacitance            | $C_{iss}$ | $V_{DS}=20V, V_{GS}=0V, f=1MHz$ | pF   | —   | 910 | —   |
| Output Capacitance           | $C_{oss}$ |                                 |      | —   | 485 | —   |
| Reverse Transfer Capacitance | $C_{rss}$ |                                 |      | —   | 11  | —   |

● Switching Parameters

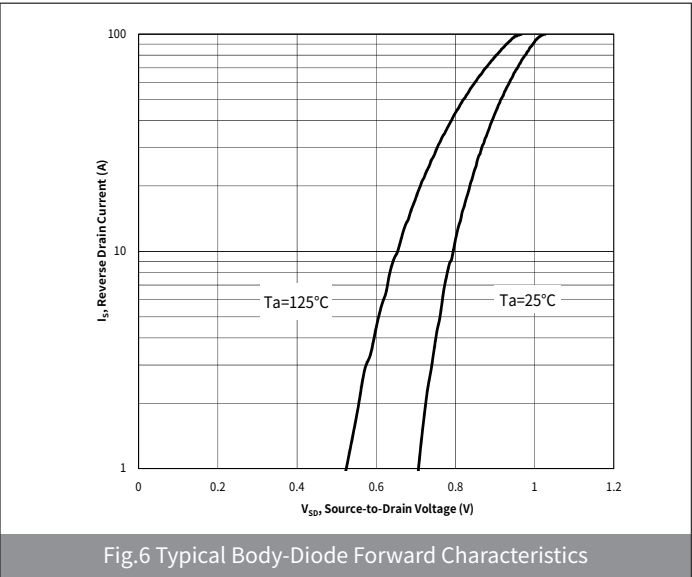
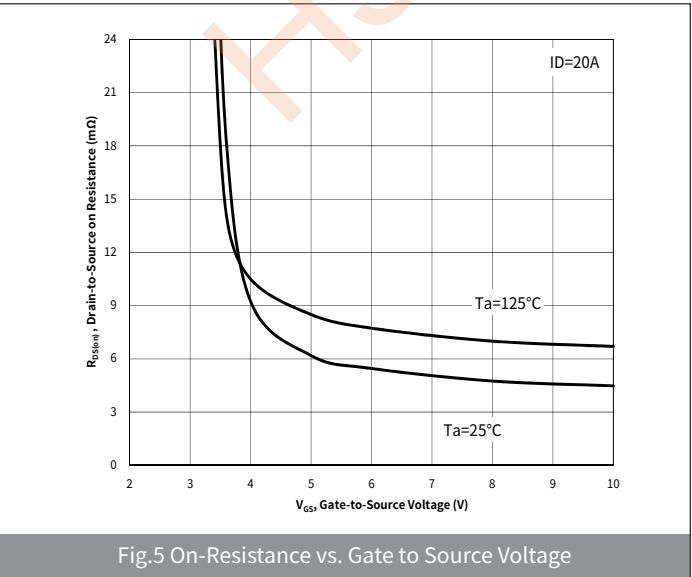
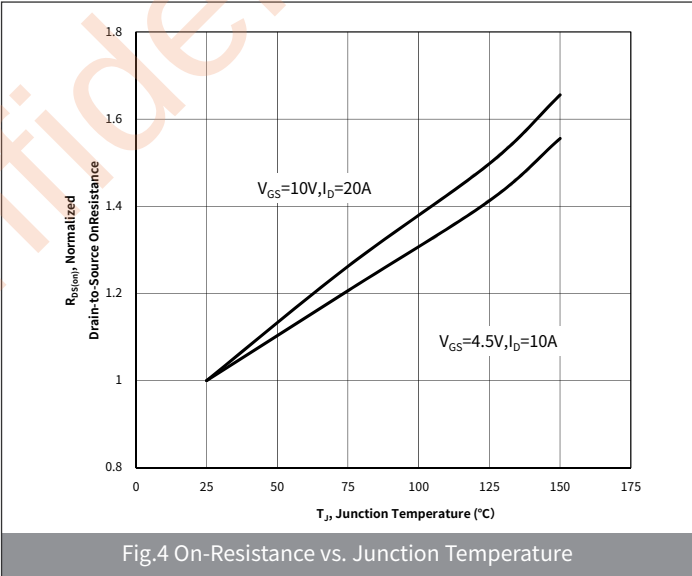
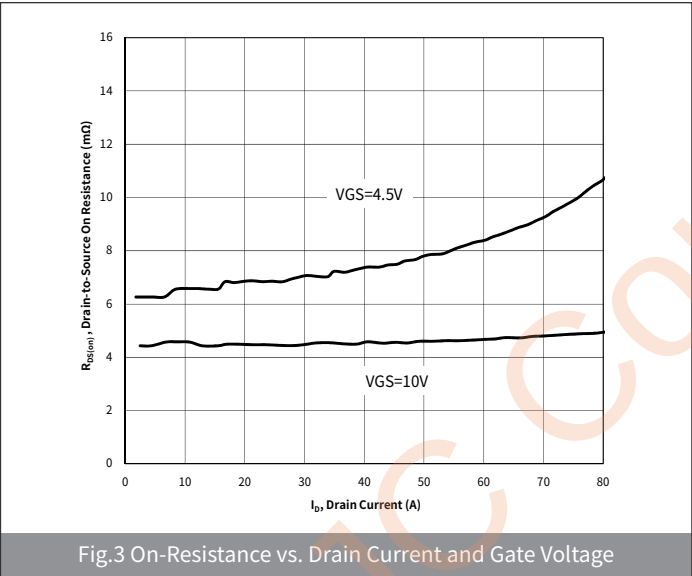
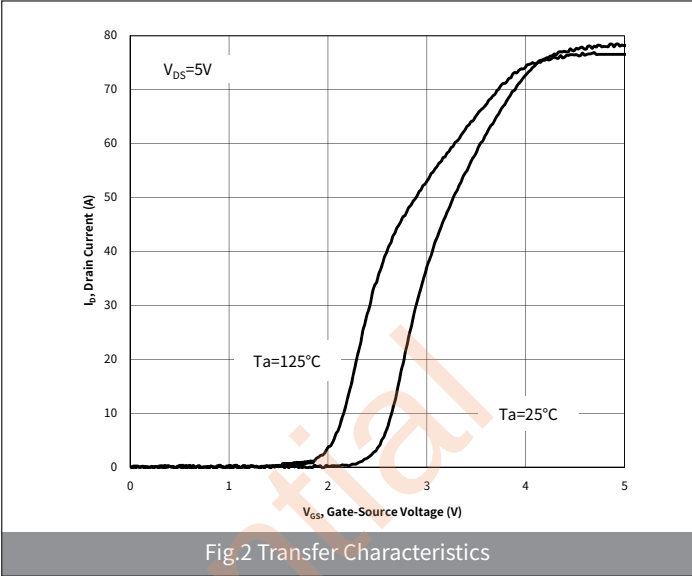
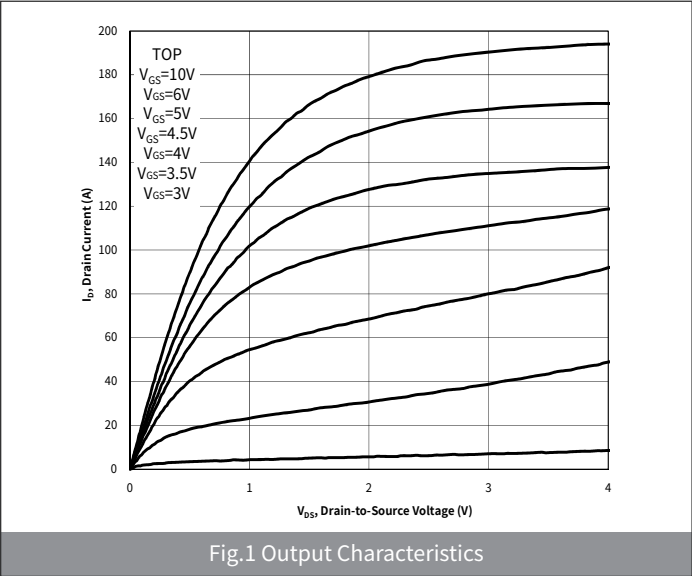
| PARAMETER           | SYMBOL       | Condition                                          | UNIT | Min | Typ | Max |
|---------------------|--------------|----------------------------------------------------|------|-----|-----|-----|
| Turn-on Delay Time  | $t_{D(on)}$  | $V_{GS}=10V, V_{DD}=20V, I_D=30A, R_{GEN}=3\Omega$ | nS   | —   | 8   | —   |
| Turn-on Rise Time   | $t_r$        |                                                    | nS   | —   | 5   | —   |
| Turn-off Delay Time | $t_{D(off)}$ |                                                    | nS   | —   | 24  | —   |
| Turn-off fall Time  | $t_f$        |                                                    | nS   | —   | 3.5 | —   |
| Total Gate Charge   | $Q_g$        | $V_{DS}=20V, I_D=30A, V_{GS}=10V$                  | nC   | —   | 35  | —   |
| Gate-Source Charge  | $Q_{gs}$     |                                                    | nC   | —   | 6.4 | —   |
| Gate-Drain Charge   | $Q_{gd}$     |                                                    | nC   | —   | 3.5 | —   |

● Drian-Source Diode Characteristics

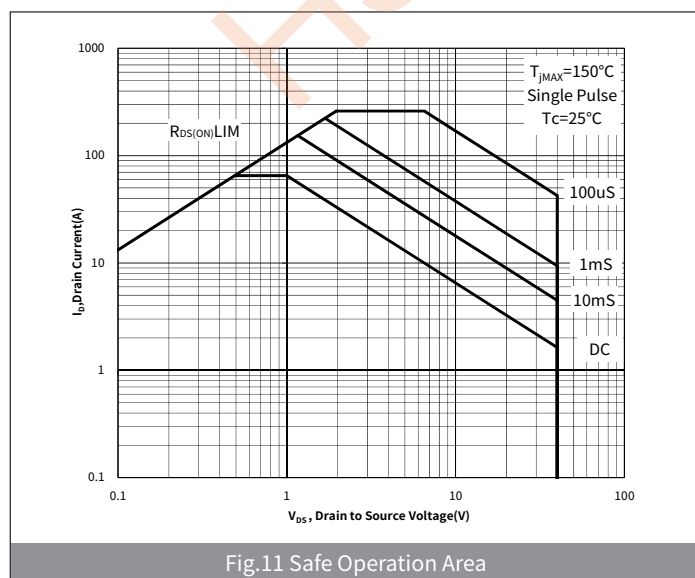
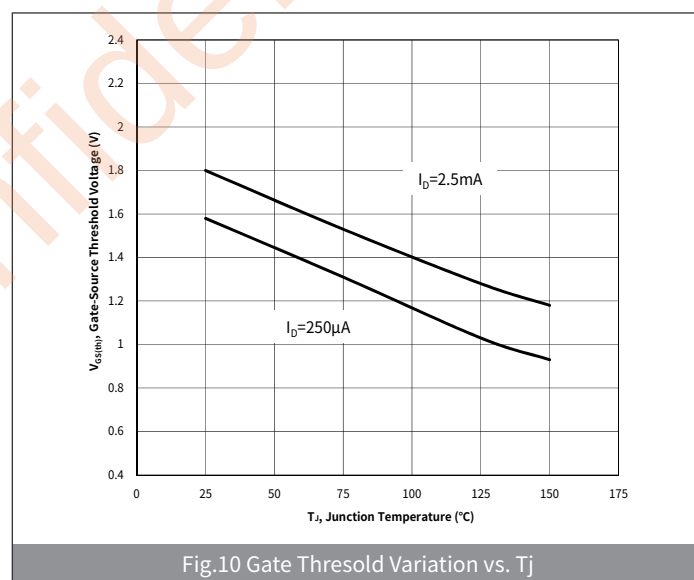
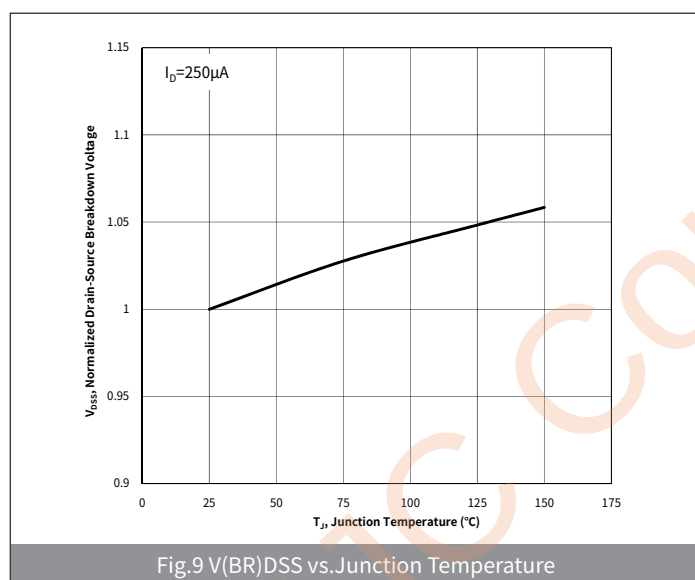
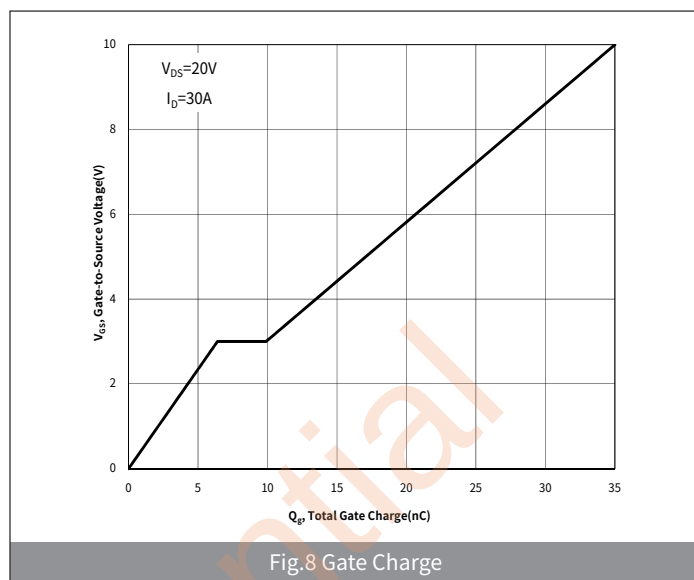
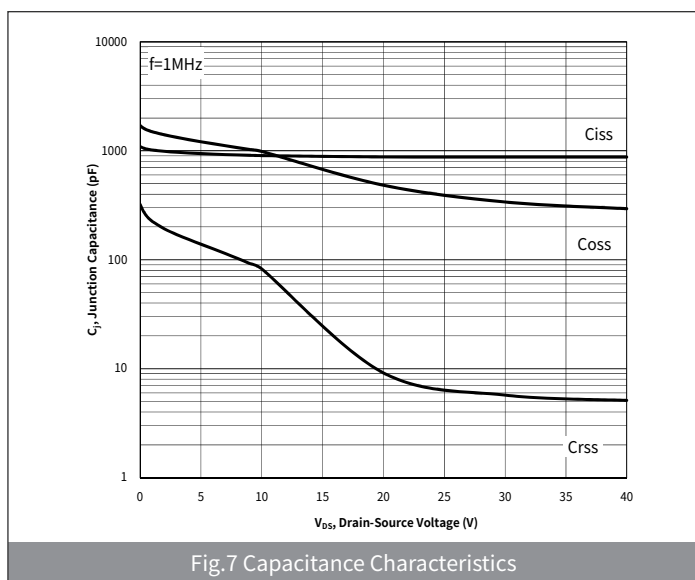
| PARAMETER                             | SYMBOL   | Condition                                | UNIT | Min | Typ | Max |
|---------------------------------------|----------|------------------------------------------|------|-----|-----|-----|
| Diode Forward Voltage                 | $V_{SD}$ | $I_S=65, V_{GS}=0V$                      | V    | —   | —   | 1.2 |
| Maximum Body-Diode Continuous Current | $I_S$    | —                                        | A    | —   | —   | 65  |
| Reverse Recovery Time                 | $V_{rr}$ | $I_S=65A, di/dt=100A/us, T_J=25^\circ C$ | nS   | —   | 14  | —   |
| Reverse Recovery Charge               | $Q_{rr}$ |                                          | nC   | —   | 16  | —   |

Note :  
(1)Repetitive Rating: Pulse width limited by maximum junction temperature.  
(2)EAS condition : Tj=25°C ,VDD=20V,VG=10V,L=0.5mH,IAS=21A,Rg=25Ω.  
(3)Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.

● Ratings And Characteristics Curves (Ta=25°C Unless otherwise specified)



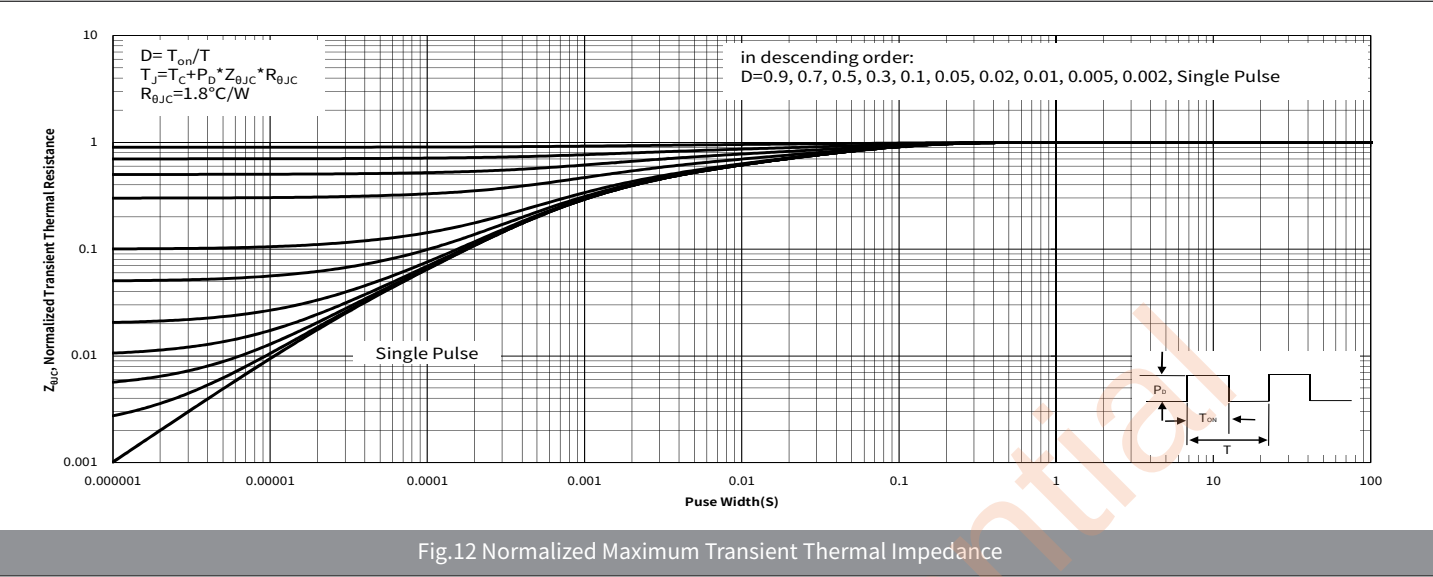
## ● Ratings And Characteristics Curves (Ta=25°C Unless otherwise specified)



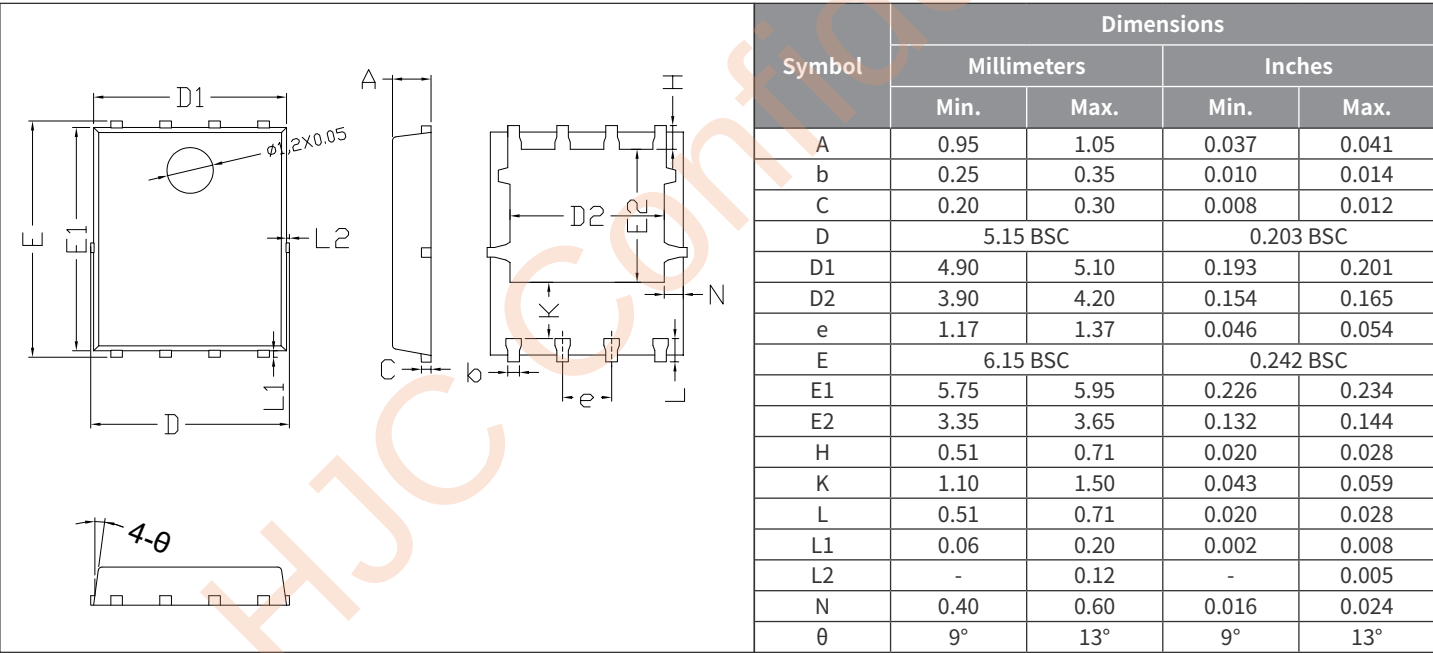
# HD504N060SG

N-CHANNEL MOSFET

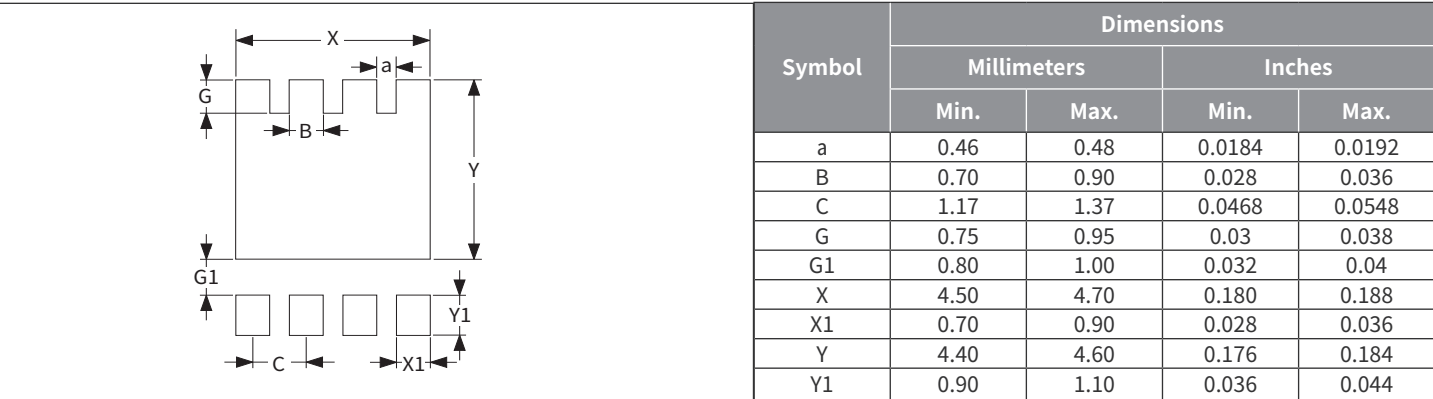
## Ratings And Characteristics Curves (Ta=25°C Unless otherwise specified)



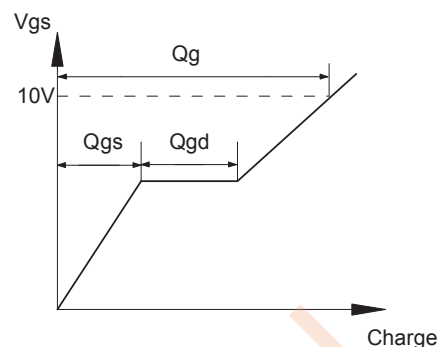
## Package Outline Dimensions (PDFN5060)



## Suggested Pad Layout



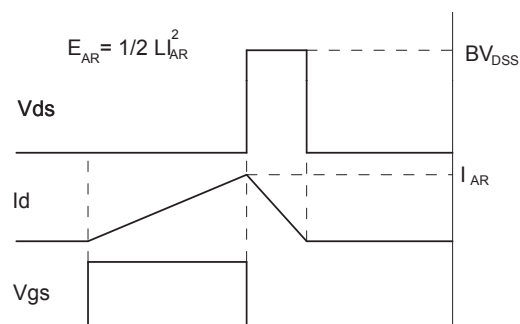
## 1. Gate Charge Test Circuit & Waveforms



## 2. Resistive Switching Test Circuit & Waveforms



## 3. Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



## 4. Diode Recovery Test Circuit & Waveforms

